



## EOL NOTICE # 130403

### Date:

April 3, 2013

### Product:

XBee Wi-Fi (S6) Development Kit

### Notice:

Effective April 3, 2013, Digi will begin the EOL process for the XBee Wi-Fi (S6) Development Kit. These kits will be replaced with the new XBee Wi-Fi (S6B) Development Kit, which includes the new and improved XBee Wi-Fi (S6B) Modules.

### Recommendation:

Digi recommends that all distributors return their existing inventory of the XBee Wi-Fi (S6) Development Kits and replace them with the new S6B version. **The S6 version will be officially EOL on June 3, 2013.**

### Affected Part Numbers:

Old Part#	Replacement Part#
XK2-WFT-0	XK2B-WFT-0 XK2B-WFT-J0 (Japan Only)

### Additional Information:

The S6 Development Kit contains 2 through-hole modules. The new S6B Development Kit will include 1 through-hole module and 1 surface-mount module. For more information about the differences between the S6 and S6B, please refer to the Migration Guide.

If you have concerns or questions about this notice please contact our Support department via telephone at 801-765-9885, via email at [rf-experts@digi.com](mailto:rf-experts@digi.com) or visit us online at <http://www.digi.com/support/eservice/> to submit a request.

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